

# User's Guide

# NHD-12864AZ-NSW-BBW-TR

# LCM

(Liquid Crystal Display Graphic Module)

**RoHS Compliant**

<b>NHD-</b>	Newhaven Display
<b>12864-</b>	128 x 64 pixels
<b>AZ-</b>	Version Line
<b>N-</b>	Transmissive
<b>SW-</b>	Side White LED B/L
<b>B-</b>	STN-(negative)Blue
<b>B-</b>	6:00 View
<b>W-</b>	Wide Temperature (-20 ~ +70c)
<b>TR-</b>	<b>Auto Contrast</b>

---

For product support, contact

**Newhaven Display International, LLC**  
**2511 Technology Drive, #101**  
**Elgin, IL 60124**

Tel: (847) 844-8795 Fax: (847) 844-8796

February 29, 2008

# NHD-12864AZ-NS(W) -BBW-TR

## SPECIFICATIONS OF LCD MODULE

NHD-12864AO is a dot matrix graphic LCD module which is fabricated by low power CMOS technology. It can display 128\*64 dots size LCD panel using a 128\*64 bit-mapped Display Data RAM (DDRAM). It interfaces with an 8-bit microprocessor.

### Features

- ≠ Display format: 128\*64 dots matrix graphic
- ≠ STN-**BLUE** negative image mode
- ≠ Easy interface with 8-bit MPU
- ≠ Low power consumption
- ≠ LED Side back-light (white)
- ≠ Viewing angle: 6 O'clock
- ≠ Driving method: 1/64 duty, 1/9 bias
- ≠ LCD driver IC: KS0108B, KS0107B
- ≠ Connector: zebra

### Mechanical Specifications

Item	Dimension	Unit
Module Size(W*H*T)	93.0*70.0*10.0	mm
Viewing Area(W*H)	72.0*40.0	mm
Number of Dots	128.0*64.0	PCS
Dot Size(W*H)	0.48*0.48	mm
Dot Pitch(W*H)	0.52*0.52	mm
Module Size With B/L	93.0*70.0*15.0	mm

### Temperature Characteristics

Parameter	Symbol	Rating	Unit
Operating temperature	Topr	-20 ~ +70	
Storage temperature	Tstg	-30 ~ +80	

### Electrical Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Operating voltage	V <sub>DD</sub>	-0.3 ~ +7.0	V
Supply voltage	V <sub>EE</sub>	V <sub>DD</sub> -10.0 ~ V <sub>DD</sub> +0.3	V
Driver supply voltage	V <sub>B</sub>	-0.3 ~ V <sub>DD</sub> +0.3	V
	V <sub>LCD</sub>	V <sub>EE</sub> -0.3 ~ V <sub>DD</sub> +0.3	V

**Figure 1. External Dimensions**

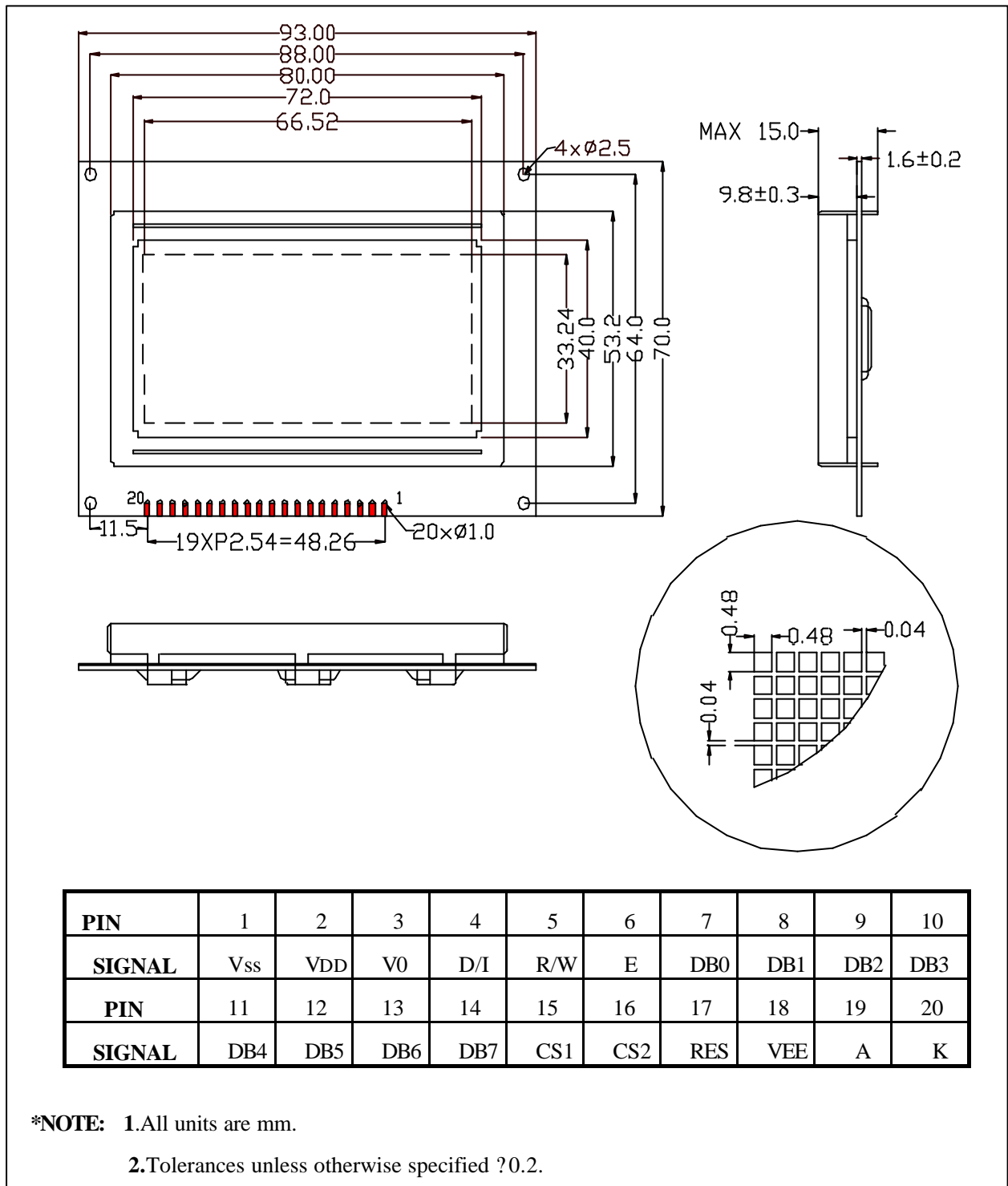
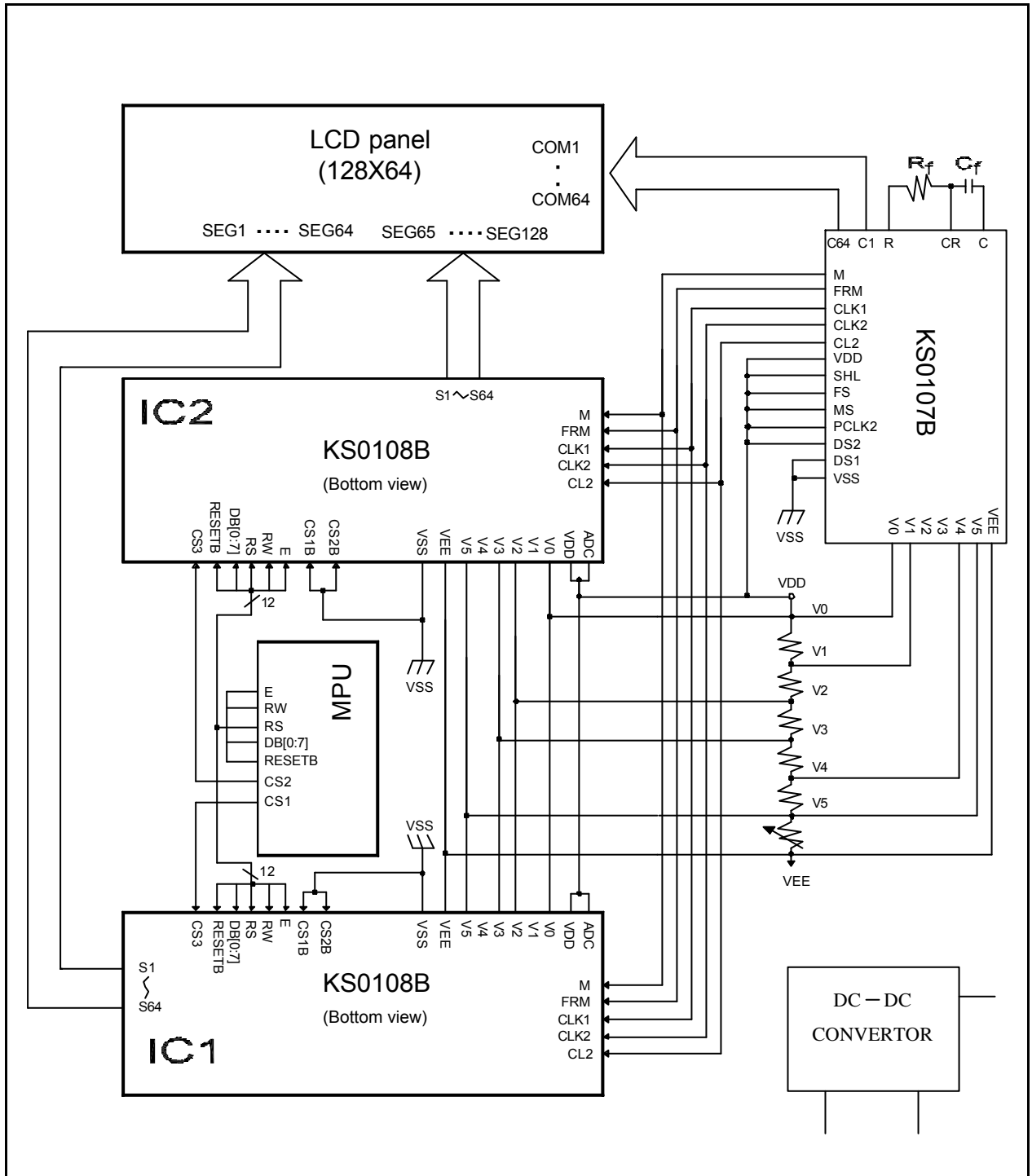


Figure 2. Application Diagram



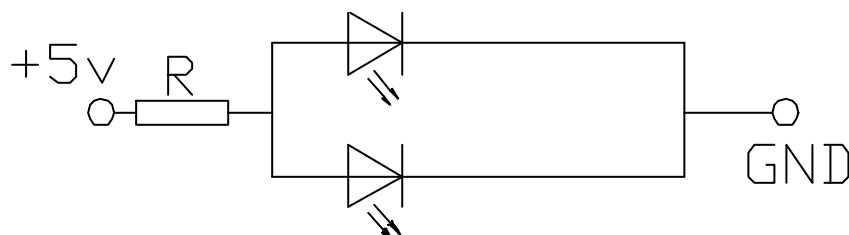
**\*Note**

1/64 duty, 1/9 bias  
 $V_{DD} > V1 > V2 > V3 > V4 > V5 > V_{EE}$

## Interface Pin Connections

Pin No.	Symbol	I/O Type	Description
1	VSS	Supply	VSS: GND
2	VDD		Power supply(+5v)
3	V0		LCD driver supply voltage
4	D/I		Register select signal
5	R/W		Read/write select signal
6	E		Operation (data read/write) enable signal
7	DB0	I/O	Data bus [0~7] Bi-directional data bus
8	DB1		
9	DB2		
10	DB3		
11	DB4		
12	DB5		
13	DB6		
14	DB7		
15	CS1	I	Chip selection: When CS1=H,CS2=L, select IC1 When CS1=L,CS2=H, select IC2
16	CS2		
17	RESET	I	Reset signal. When RSTB=L  【1】 ON/OFF register becomes set by 0.(display off) 【2】 display start line register becomes set by 0 (Z-address 0 set, display from line 0) 【3】 After releasing reset , this condition can be changed only by instruction.
18	VEE	Power	VEE is connected by the same voltage.
19	A		Back-light anode
20	K		Back-light cathode

### Backlight circuit diagram(light 2X6)



### LED ratings

5V,R=51 )

(voltage=

Item	Symbol	Min	Typ.	Max	Unit
Forward Voltage	$V_F$	-	3.4	3.7	V
Forward current	$I_F$	-		50	mA
Power	P			180	mW

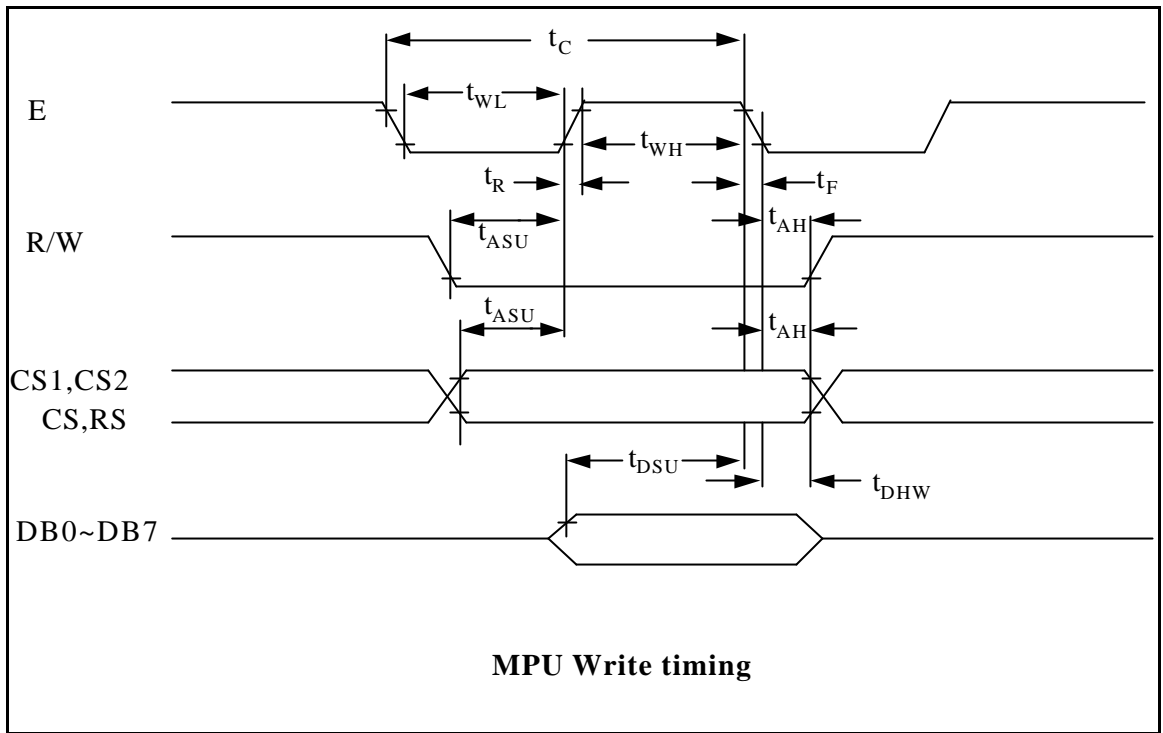
Peak wave length	p				nm
Luminance	Lv		80		Cd/m <sup>2</sup>

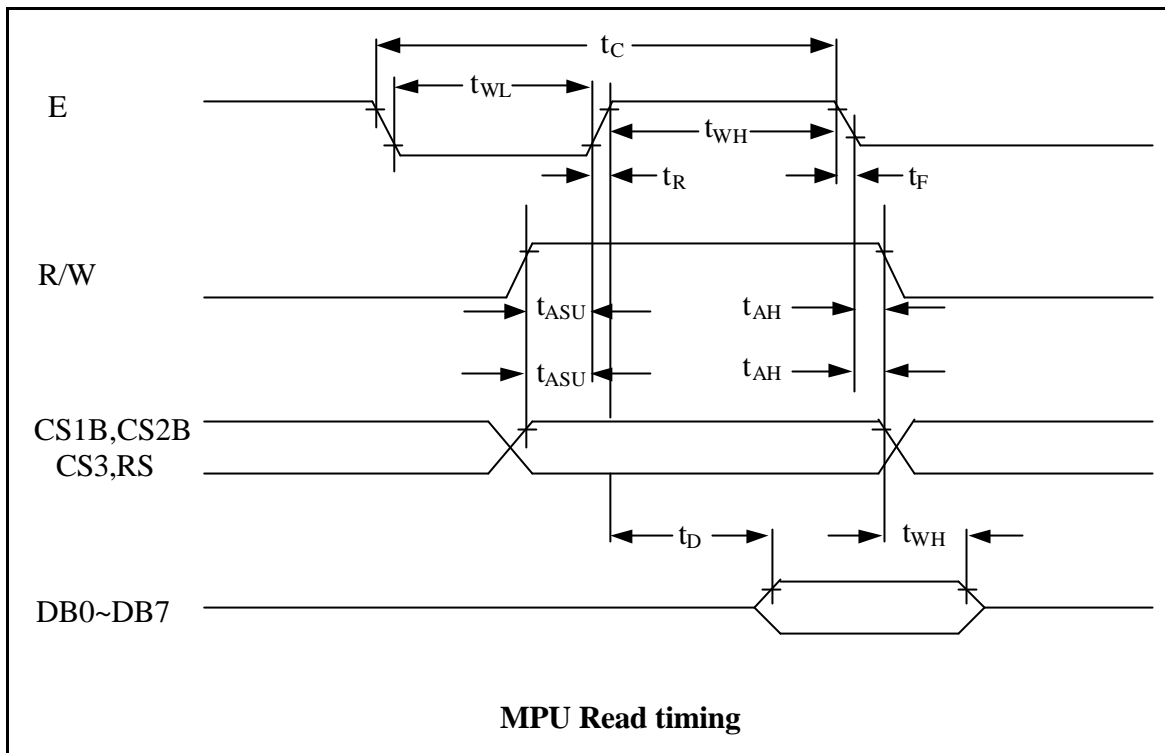
### DC Electrical Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Supply voltage for LCD	V <sub>DD-V0</sub>	Ta =25	-	13.8	-	V
Input voltage	V <sub>DD</sub>		4.7	-	5.5	
Supply current	I <sub>DD</sub>	Ta=25 , V <sub>DD</sub> =5.0V	-	3.5	5.5	mA
Input leakage current	I <sub>LKG</sub>		-	-	1.0	uA
“H” level input voltage	V <sub>IH</sub>		2.2	-	V <sub>DD</sub>	V
“L” level input voltage	V <sub>IL</sub>	Twice initial value or less	0	-	0.6	
“H” level output voltage	V <sub>OH</sub>	LOH=-0.25mA	2.4	-	-	
“L” level output voltage	V <sub>OL</sub>	LOH=1.6mA	-	-	0.4	
Backlight supply voltage	V <sub>F</sub>		-	3.4	3.6	
Backlight supply current	I <sub>F</sub>	V=5.0V R=51	-	33		mA

### ( 3 ) . MPU Interface

Characteristic	Symbol	Min	Typ	Max	Unit
E Cycle	t <sub>c</sub>	1000	-	-	ns
E High Level Width	t <sub>WH</sub>	450	-	-	
E Low Level Width	t <sub>WL</sub>	450	-	-	
E Rise Time	t <sub>R</sub>	-	-	25	
E Fall Time	t <sub>F</sub>	-	-	25	
Address Set-Up Time	t <sub>ASU</sub>	140	-	-	
Address Hold Time	t <sub>AH</sub>	10	-	-	
Data Set-Up Time	t <sub>SU</sub>	200	-	-	
Data Delay Time	t <sub>D</sub>	-	-	320	
Data Hold Time (Write)	t <sub>DHW</sub>	10	-	-	
Data Hold Time (Read)	t <sub>DHR</sub>	20	-	-	





## OPERATING PRINCIPLES & METHODS

### 1. I/O Buffer

Input buffer controls the status between the enable and disable of chip. Unless the CS1B to CS3 is in active mode, Input or output of data and instruction does not execute. Therefore internal state is not change. But RSTB and ADC can operate regardless CS1B-CS3.

### 2. Input register

Input register is provided to interface with MPU which is different operating frequency. Input register stores the data temporarily before writing it into display RAM.

When CS1B to CS3 are in the active mode, R/W and RS select the input register. The data from MPU is written into input register. Then writing it into display RAM. Data latched for falling of the E signal and write automatically into the display data RAM by internal operation.

### 3. Output register

Output register stores the data temporarily from display data RAM when CS1B, CS2B and CS3 are in active mode and R/W and RS=H, stored data in display data RAM is latched in output register. When CS1B to CS3 is in active mode and R/W=H, RS=L, status data (busy check) can read out.

To read the contents of display data RAM, twice access of read instruction is needed. In first access, data in display data RAM is latched into output register. In second access, MPU can read data which is latched. That is to read the data in display data RAM, it needs dummy read. But status read is not needed dummy read.



RS	R/W	Function
L	L	Instruction
	H	Status read (busy check)
H	L	Data write (from input register to display data RAM )
	H	Data read (from display data RAM to output register)

**4. Reset**

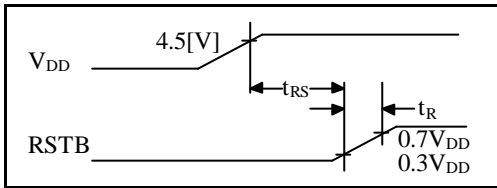
The system can be initialized by setting RSTB terminal at low level when turning power on, receiving instruction from MPU. When RSTB becomes low, following procedure is occurred.

1. Display off
2. Display start line register become set by 0.(Z-address 0)

While RSTB is low, No instruction except status read can be accepted. Therefore, execute other instructions after making sure that DB4= (clear RSTB) and DB7=0 (ready) by status read instruction. The conditions of power supply at initial power up are shown in table 1.

Table 1. Power Supply Initial Conditions

Item	Symbol	Min	Typ	Max	Unit
Reset Time	$t_{RS}$	1.0	-	-	us
Rise Time	$t_R$	-	-	200	ns

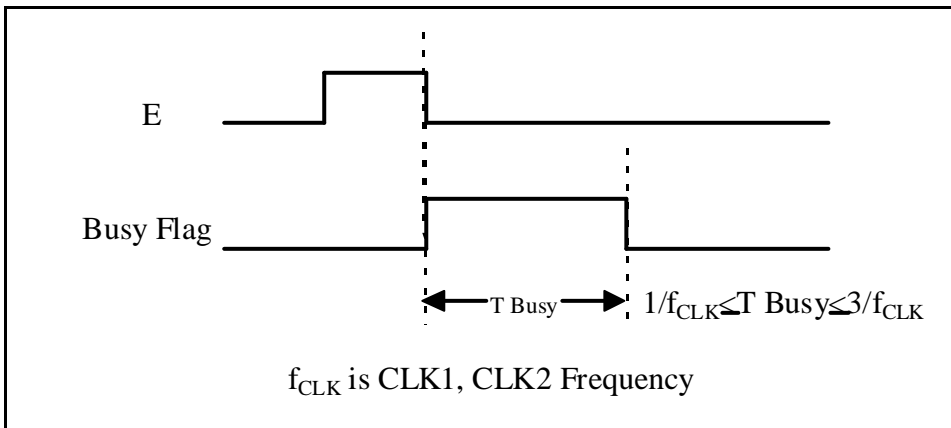


**5. Busy flag**

Busy flag indicates that KS0108B is operating or no operating. When busy flag is high, KS0108B is in internal operating .

When busy flag is low, KS0108B can accept the data or instruction.

DB7indicates busy flag of the KS0108B.



**6. Display On/Off Flip-Flop**

The display on/off flip-flop makes on/off the liquid crystal display. When flip-flop is reset (logical low), selective voltage or non selective voltage appears on segment output terminals. When flip-flop is set (logic high), non selective voltage appears on segment output terminals regardless of display RAM data. The display on/off flip-flop can changes status by instruction. The display data at all segment disappear while RSTB is low.

The status of the flip-flop is output to DB5 by status read instruction.

The display on/off flip-flop synchronized by CL signal.

**7. X Page Register**

X page register designates pages of the internal display data RAM.

Count function is not available. An address is set by instruction.

**8. Y address counter**

Y address counter designates address of the internal display data RAM. An address is set by instruction and is increased by 1 automatically by read or write operations of display data.

**9. Display Data RAM**

Display data RAM stores a display data for liquid crystal display. To indicate on state dot matrix of liquid crystal display , write data1. The other way , off state, writes 0.

Display data RAM address and segment output can be controlled by ADC signal.

ADC=H => Y-address 0: S1~Y address 63: S64

ADC=L => Y-address 0: S64~Yaddress 63: S1

ADC terminal connect the  $V_{DD}$  or  $V_{SS}$ .

**10. Display Start Line Register**

The display start line register indicates of display data RAM to display top line of liquid crystal display.

Bit data (DB<0.5>) of the display start line set instruction is latched in display start line register. Latched data is transferred to the Z address counter while FRM is high, presetting the Z address counter.

It is used for scrolling of the liquid crystal display screen.

## Display Control Instruction

The display control instructions control the internal state of the KS0108B. Instruction is received from MPU to KS0108B for the display control. The following table shows various instructions.

Instruction	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Function
Read Display Date	1	1	Read data								Reads data (DB[7:0]) from display data RAM to the data bus.
Write Display Date	1	0	Write data								Writes data (DB[7:0]) into the DDRAM. After writing instruction, Y address is incremented by 1 automatically
Status Read	0	1	Busy	0	ON/OFF	Reset	0	0	0	0	Reads the internal status BUSY 0: Ready 1: In operation ON/OFF 0: Display ON 1: Display OFF RESET 0: Normal 1: Reset
Set Address (Y address)	0	0	0	1	Y address (0~63)						Sets the Y address at the column address counter
Set Display Start Line	0	0	1	1	Display start line (0~63)						Indicates the Display Data RAM displayed at the top of the screen.
Set Address (X address)	0	0	1	0	1	1	1	Page (0~7)			Sets the X address at the X address register.
Display On/off	0	0	0	0	1	1	1	1	1	0/1	Controls the display ON or OFF. The internal status and the DDRAM data is not affected. 0: OFF, 1: ON

### 1. Display On/Off

The display data appears when D is 1 and disappears when D is 0. Though the data is not on the screen with D=0, it remains in the display data RAM. Therefore, you can make it appear by changing D=0 into D=1.

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	1	1	1	1	1	D

### 2. Set Address (Y Address)

Y address (AC0~AC5) of the display data RAM is set in the Y address counter. An address is set by instruction and increased by 1 automatically by read or write operations of display data.

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0

**3. Set Page (X Address)**

X address (AC0~AC2) of the display data RAM is set in the X address register.  
 Writing or reading to or from MPU is executed in this specified page until the next page is set.

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	0	1	1	1	AC2	AC1	AC0

**4. Display Start Line (Z Address)**

Z address (AC0~AC5) of the display data RAM is set in the display start line register and displayed at the top of the screen.  
 When the display duty cycle is 1/64 or others (1/32~1/64), the data of total line number of LCD screen, from the line specified by display start line instruction, is displayed.

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	1	AC5	AC4	AC3	AC2	AC1	AC0

**5. Status Read**

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	0	BUSY	0	ON/OFF	RESET	0	0	0	0

- ⌘ BUSY  
 When BUSY is 1, the Chip is executing internal operation and no instructions are accepted.  
 When BUSY is 0, the Chip is ready to accept any instructions.
- ⌘ ON/OFF  
 When ON/OFF is 1, the display is on.  
 When ON/OFF is 0, the display is off.
- ⌘ RESET  
 When RESET is 1, the system is being initialized.  
 In this condition, no instructions except status read can be accepted.  
 When RESET is 0, initializing has finished and the system is in the usual operation condition.

**6. Write Display Data**

Writes data (D0~D7) into the display data RAM.  
 After writing instruction, Y address is increased by 1 automatically.

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	0	D7	D6	D5	D4	D3	D2	D1	D0

**7. Read Display Data**

Reads data (D0~D7) from the display data RAM.  
 After reading instruction, Y address is increased by 1 automatically.

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	1	D7	D6	D5	D4	D3	D2	D1	D0